

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
40V	1.4mΩ@10V	210A
	1.9mΩ@4.5V	

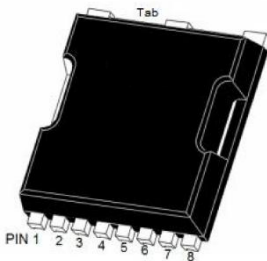
### Feature

- Split gate trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$
- Suffix "-Q1" for AEC-Q101

### Application

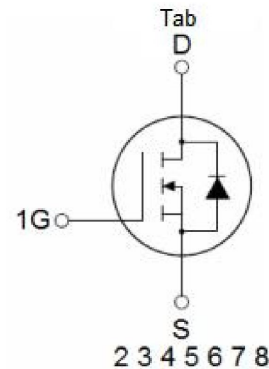
- DC/DC Converter
- Power switching application
- Uninterruptible power supply

### Package

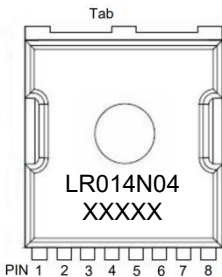


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### Circuit diagram



### Marking



### Absolute maximum ratings ( $T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current ( $T_C=25^\circ\text{C}$ ) <sup>1,2)</sup>	$I_D$	210	A
Continuous Drain Current ( $T_C=100^\circ\text{C}$ ) <sup>1,2)</sup>	$I_D(100^\circ\text{C})$	132	A
Pulsed Drain Current ( $T_C=25^\circ\text{C}, t_p=100\mu\text{s}$ )	$I_{DM}$	840	A
Power Dissipation ( $T_C=25^\circ\text{C}$ ) <sup>1,2)</sup>	$P_D$	113	W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.1	$^\circ\text{C}/\text{W}$
Single pulse avalanche Energy <sup>4)</sup>	$E_{AS}$	600.25	mJ
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

### Electrical characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	40			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 40V, V_{GS} = 0V$			1	$\mu\text{A}$
		$V_{DS} = 40V, V_{GS} = 0V, T_J = 150^\circ\text{C}$			100	
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.3	1.8	2.3	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 50A$		1.0	1.4	m $\Omega$
		$V_{GS} = 4.5V, I_D = 25A$		1.4	1.9	
<b>Dynamic characteristics<sup>3)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 20V, V_{GS} = 0V, f = 1\text{MHz}$		6140		pF
Output Capacitance	$C_{oss}$			1860		
Reverse Transfer Capacitance	$C_{rss}$			75		
Total Gate Charge	$Q_g$	$V_{DS} = 20V, V_{GS} = 10V, I_D = 50A$		89		nC
Gate-Source Charge	$Q_{gs}$			18		
Gate-Drain Charge	$Q_{gd}$			15		
Gate Resistance	$R_g$	$f = 1\text{MHz}$		3.3		$\Omega$
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 20V, V_{GS} = 10V, I_D = 50A, R_{GEN} = 3\Omega$		14		nS
Turn-on rise time	$t_r$			15		
Turn-off delay time	$t_{d(off)}$			84		
Turn-off fall time	$t_f$			44		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	$V_{SD}$	$V_{GS} = 0V, I_S = 50A$			1.2	V
Diode Forward Current	$I_S$				210	A
Reverse Recovery Time	$t_{rr}$	$I_F = 50A, di/dt = 100A/\mu\text{s}$		55		nS
Reverse Recovery Charge	$Q_{rr}$			53		nC

Notes:

- 1) The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2) Thermal resistance from junction to soldering point (on the exposed drain pad).
- 3) Guaranteed by design, not subject to production.
- 4)  $V_G=10V, R_G=25\Omega, L=0.5\text{mH}, I_{AS}=49A$

## Typical Characteristics

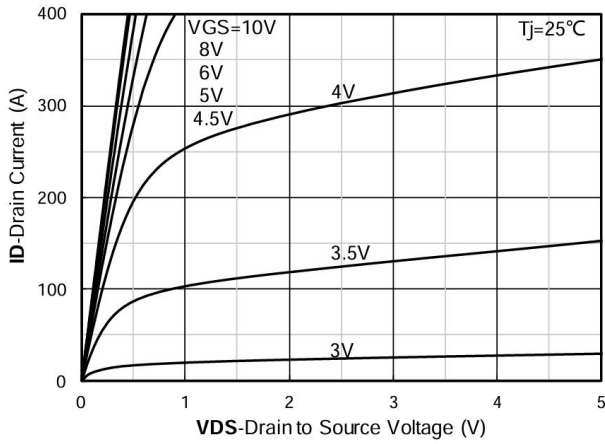


Figure 1. Output Characteristics

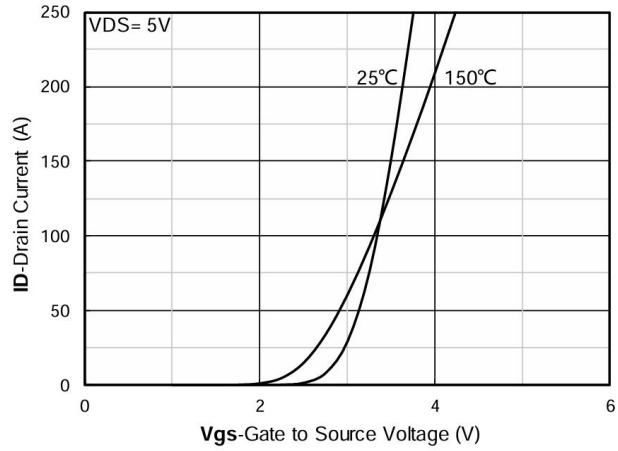


Figure 2. Transfer Characteristics

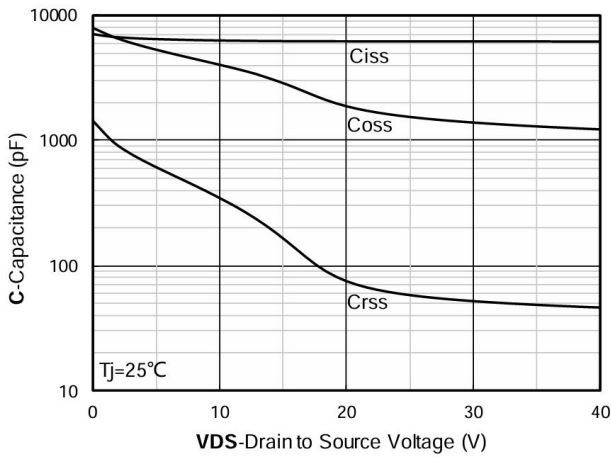


Figure 3. Capacitance Characteristics

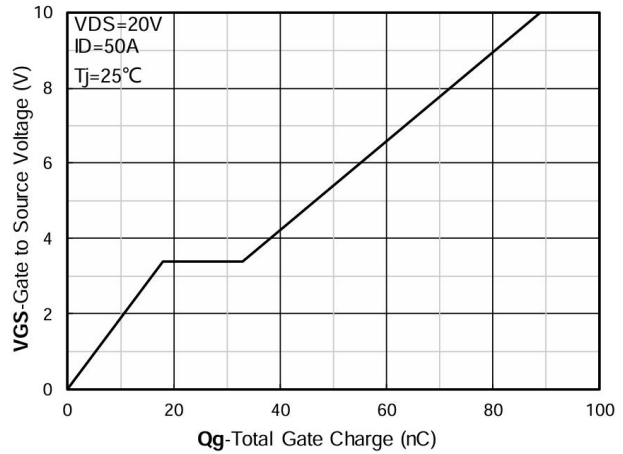


Figure 4. Gate Charge

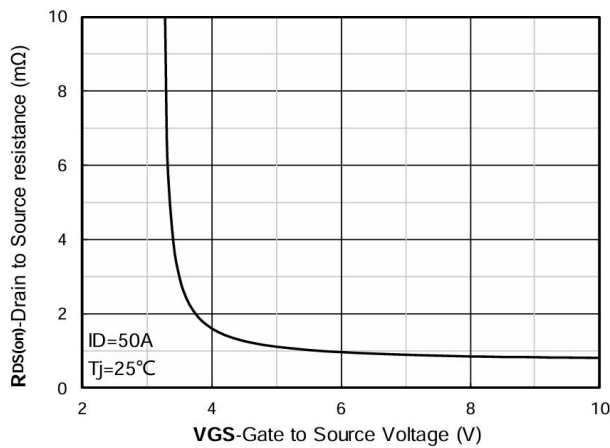


Figure 5. On-Resistance vs Gate to Source Voltage

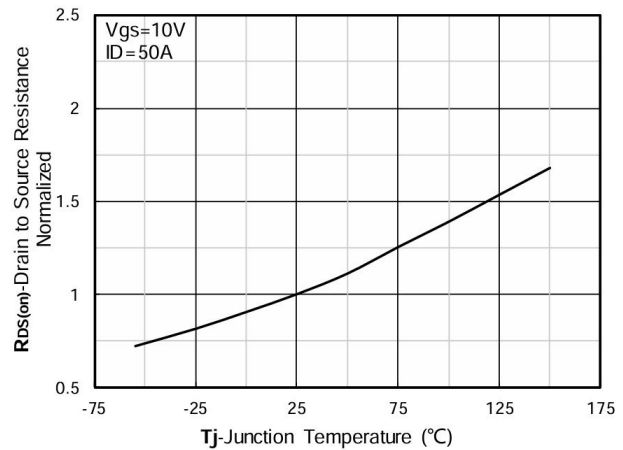


Figure 6. Normalized On-Resistance

## Typical Characteristics

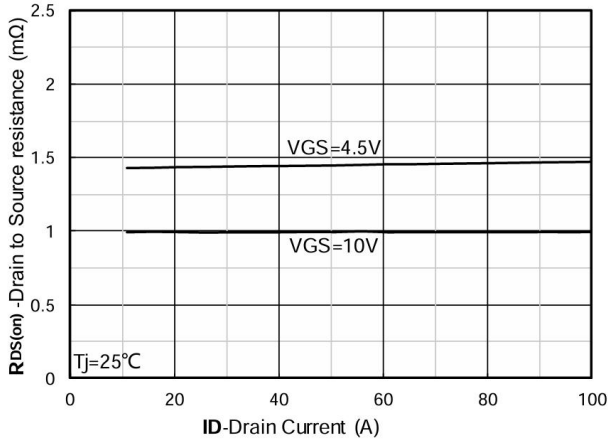


Figure 7. RDS(on) VS Drain Current

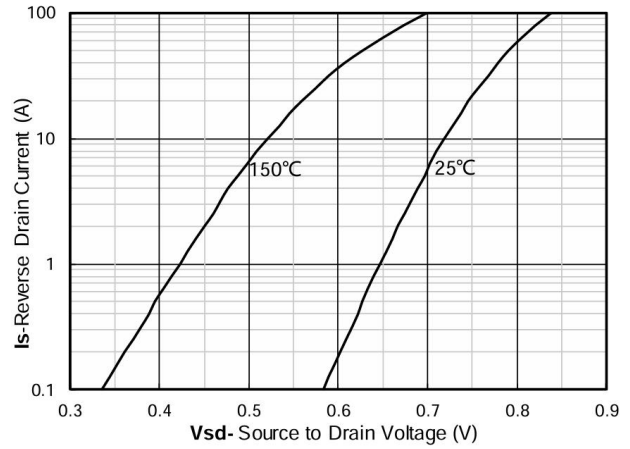


Figure 8. Forward characteristics of reverse diode

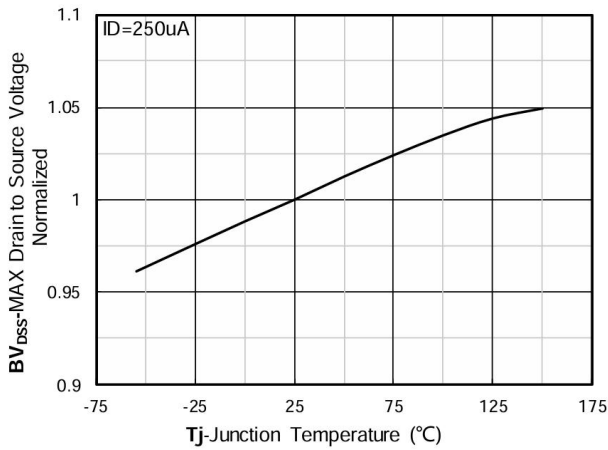


Figure 9. Normalized breakdown voltage

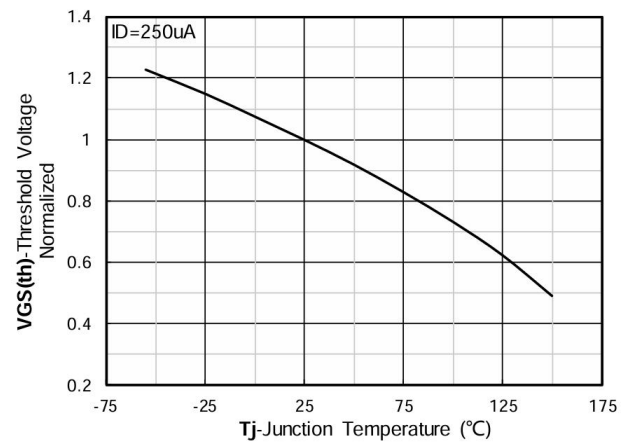


Figure 10. Normalized Threshold voltage

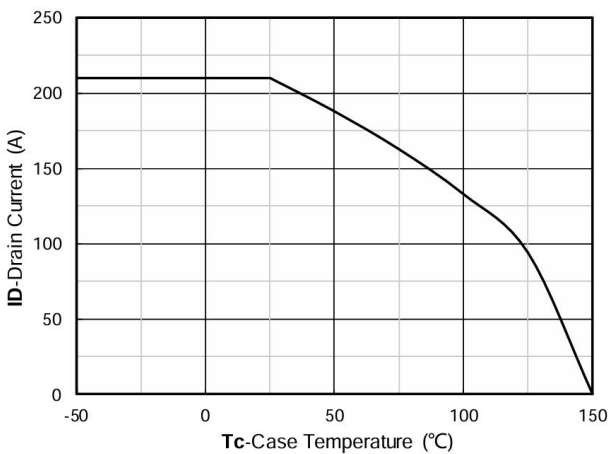


Figure 11. Current dissipation

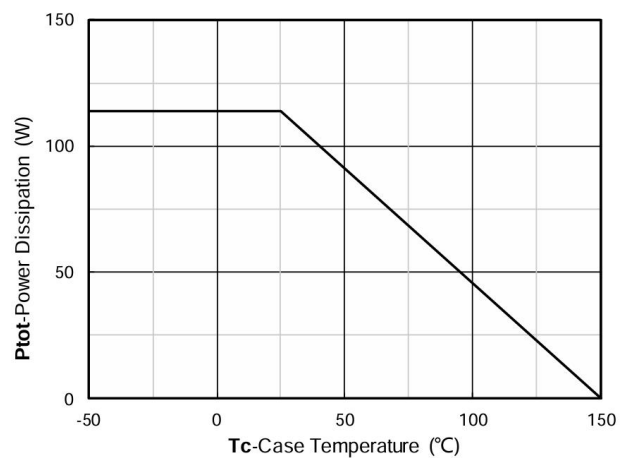


Figure 12. Power dissipation

## Typical Characteristics

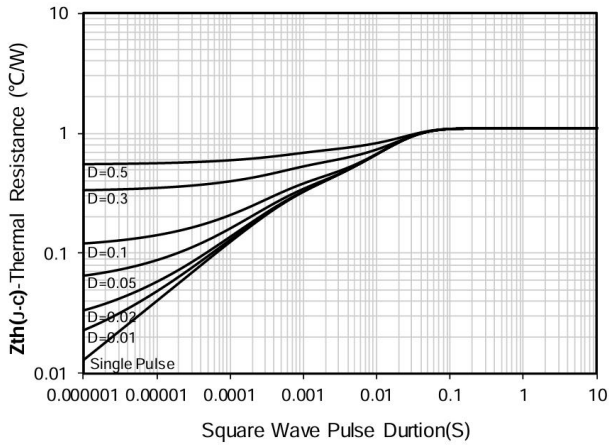


Figure 13. Maximum Transient Thermal Impedance

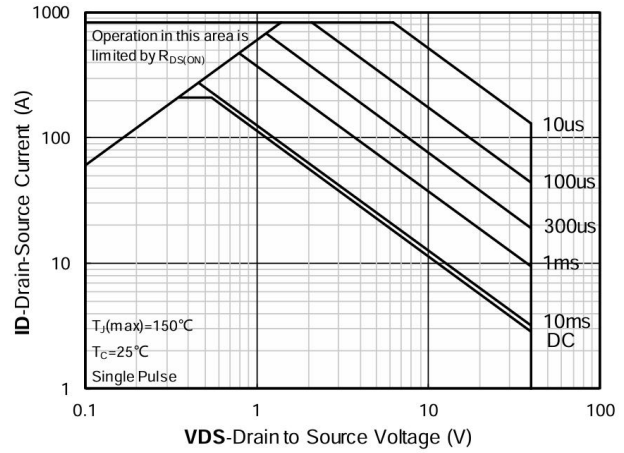
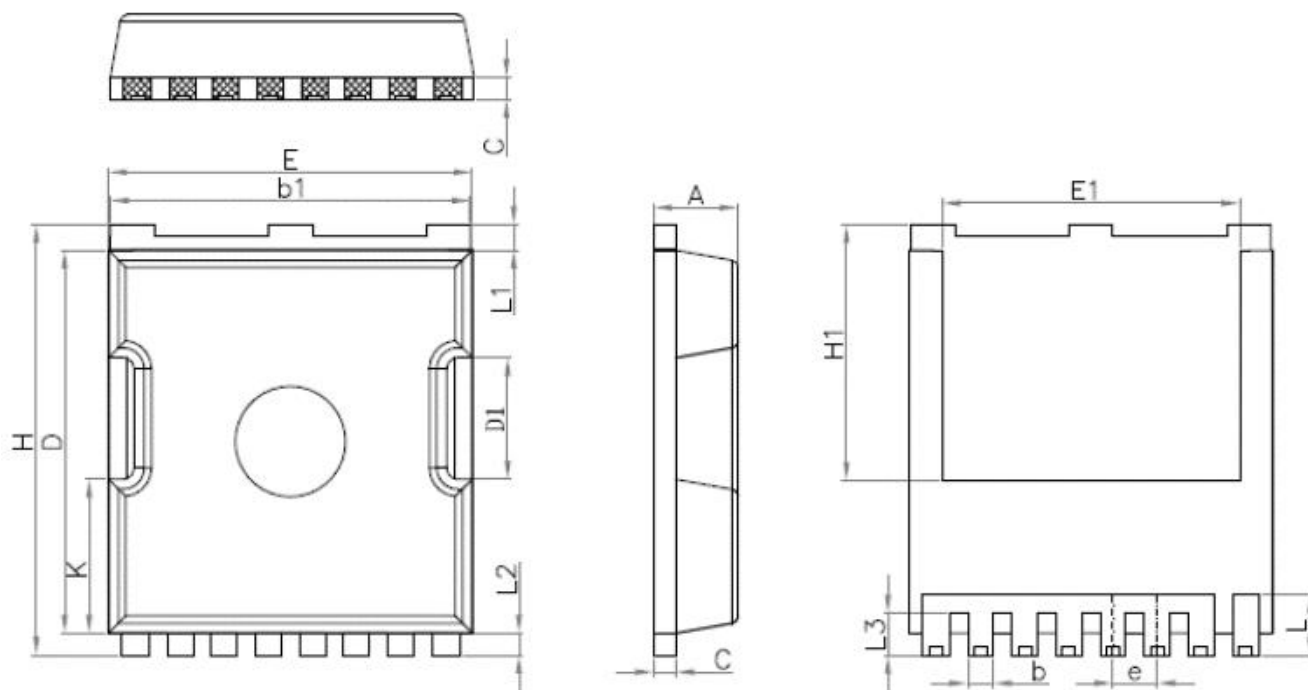


Figure 14. Safe Operation Area

### TOLL Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
b	0.650	0.900	0.026	0.035
b1	9.700	9.900	0.382	0.390
C	0.400	0.700	0.016	0.028
D	10.280	10.500	0.405	0.413
D1	3.150	3.450	0.124	0.136
E	9.700	10.100	0.382	0.398
E1	8.000	8.200	0.315	0.323
e	1.100	1.300	0.043	0.051
H	11.580	11.800	0.456	0.465
H1	6.850	7.050	0.270	0.278
K	4.080	4.280	0.161	0.169
L	1.500	2.100	0.059	0.083
L1	0.600	0.800	0.024	0.031
L2	0.500	0.700	0.020	0.028
L3	1.050	1.400	0.041	0.055